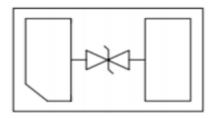


### **Description**

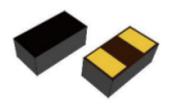
The JE05B1MD20-2 help protect sensitive electronic equipment against electrostatic discharge (ESD). They supplement the on-chip protection of integrated circuitry and are best suited for low-voltage, high-speed applications where low capacitance is important. Data ports utilizing such high-speed protocols as USB 2.0, IEEE1394, HDMI and DVI can benefit from this new technology.

#### **Circuit Diagram**



Circuit and Pin Schematic

## **Package Outline**



#### **Features**

- \* Ultra-Low capacitance: 0.05pF(typ.)
- \* Low leakage current: (<10nA)
- \* Fast response time (<1ns)
- \* Bi-directional, single line protection
- \* 2-pin leadless package
- \* Complies with following standards:
  - IEC 61000-4-2 (ESD) immunity test

Air discharge: ±15kV

Contact discharge: ±8kV

- RoHS Compliant
- \* Package:DFN1006-2

## **Applications**

- \* USB 3.0/3.1
- \* HDMI 1.3/1.4/2.0
- \* RF Antenna
- External Storage
- \* Digital Camera

## **Ordering Information**

Part Number	Packaging	Reel Size	
JE05B1MD20-2	10000/Tape & Reel	7 inch	



# Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise specified)

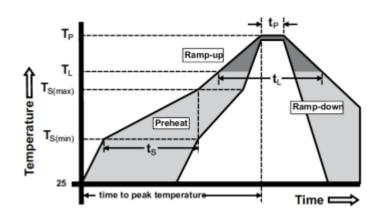
Parameter	Symbol	Value	Unit	
ESD per IEC 61000-4-2 (Air)	VESD	±15	kV	
ESD per IEC 61000-4-2 (Contact)	VESD	±8		
Operating Temperature Range	TJ	-40to 120	°C	
Storage Temperature Range	Tstg	-40to +85	°C	

# Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Continuous Operating Voltage	VDC				5	V
Trigger Voltage	$\mathbf{V}_{\mathrm{T}}$	IEC61000-4-2 8KV Contact		450		V
Clamping Voltage	$V_{\rm C}$	IEC61000-4-2 8KV Contact		40		V
Leakage Current	IL	DC 5V shall be applied on component			10	nA
Junction Capacitance	Сл	Measured at 10MHz		0.05		pF

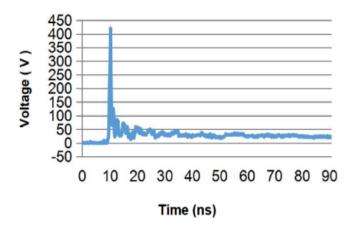
## **Soldering Parameters**

Reflow Co	ndition	Pb – Free assembly	
Pre Heat	-Temperature Min (T <sub>s(min)</sub> )	150°C	
	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (min to max) (t <sub>s</sub> )	60 – 180 seconds	
Average ramp up rate (Liquidus Temp $(T_L)$ to peak		3°C/second max	
T <sub>S(max)</sub> to T <sub>L</sub>	- Ramp-up Rate	3°C/second max	
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
	-Temperature (t <sub>L</sub> )	60 – 150 seconds	
PeakTemperature (T <sub>p</sub> )		260°C	
Time within 5°C of actual peak Temperature (t <sub>p</sub> )		10 – 30 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peakTemperature (T <sub>p</sub> )		8 minutes max	





## **Typical Performance Characteristics (T<sub>A</sub>=25°C unless otherwise Specified)**



**Figure 1. Typical ESD Response** 

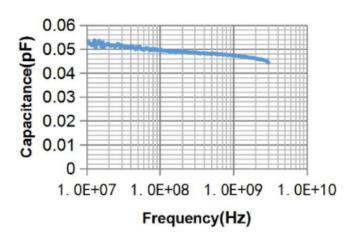


Figure 2. Typical Capacitance vs.Frequency

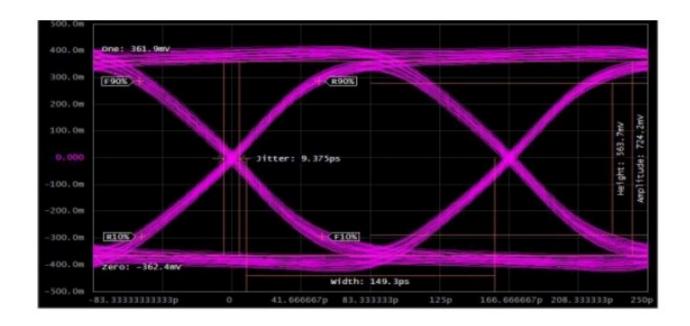
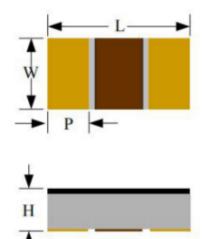


Figure 3. HDMI 2.0 Mask at 6.0 Gbps

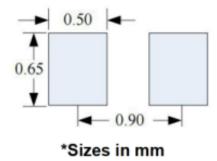


## **DFN1006-2 Package Outline Drawing** (Dimensions in millimeters)



Dim	Millimeters		
	Min	Max	
L	0.90	1.10	
W	0.42	0.62	
P	0.15	0.35	
Н	0.25	0.45	

#### **Suggested Land Pattern**



#### **NOTICE**

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